

In Re Application of Shunpei Yamazaki et al. I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Serial No.: 09/544,801 the Assistant Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on Filed: April 7, 2000 Semiconductor Device And Method For Fabricating The Same

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Examiner: Fazli Erdem

AMENDMENT G (AFTER FINAL)

Sir:

For:

Art Unit: 2826

In response to the Final Rejection dated April 24, 2006, a RCE being filed herewith, please amend the above-identified application as follows: